



anorganische chemie
meh
 materialchemie uni wien



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High Temperature
 Materials Chemistry

HTMC-XII

September 18 – 22, 2006

Vienna - Austria



FIRST ANNOUNCEMENT





GENERAL INFORMATION

HTMC-XII will be the 12th meeting in a series of conferences which are held every three years. The conference will be held for the second time **in Vienna**.

The meeting will be organized by the Department of **Inorganic Chemistry – Materials Chemistry**, University of Vienna, the **Materials Chemistry Institute**, Vienna University of Technology and the **Austrian Chemical Society (GÖCH)**.

It will take place at the Vienna University of Technology from **September 18 to 22, 2006**.

The chairmen of the meeting will be **Adolf Mikula** and **Herbert Ipser** from the University of Vienna and **Ulrich Schubert** from the Vienna University of Technology.

SCOPE

The conference will focus on new developments in **High Temperature Chemistry** covering various fields of material science.



MAIN TOPICS

- Experimental Thermodynamics and Modelling
- Ecomaterials / Special Materials
- Lamp Chemistry
- Structure and Dynamics of High Temperature Materials
- High Temperature Liquid Phase Chemistry
- Non-oxidic High Temperature Ceramics
- Lanthanides and Actinides, Nuclear Applications
- High Temperature Intermetallics / Superalloys
- Lead-free Soldering

PRESENTATION

The conference will include invited lectures and contributed papers.

The contributed papers will be accepted as oral presentations or posters.

The conference language will be English.

PROCEEDINGS

The proceedings will be published in a special issue of the **Journal of Alloys and Compounds**.



TIME AND LOCATION

The conference will be held from **September 18 to 22, 2006** at the **Vienna University of Technology** in **1040 Vienna, Wiedner Hauptstr. 8**

DEADLINES

2 nd Announcement	January 2006
Abstracts	April 10, 2006
Notification of Accept.	May 1, 2006

ACCOMMODATION

A list of hotels will be provided with the 2nd Announcement and at the conference homepage.

SOCIAL PROGRAM.

Vienna is one of the top tourist destinations in Europe and offers plenty of possibilities. A Social Program and a Program for Accompanying Persons will be organized.

HOMPEPAGE

For further information please visit the Conference Homepage:

<http://www.univie.ac.at/htmc06>

The **Preliminary Registration Form** will be on our homepage.

